

NP32N055HIL-VB Datasheet N-Channel 60-V (D-S) MOSFET

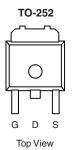
| PRODUCT SUMMARY | | | | | |
|---------------------|----------------------------------|---------------------------------|--|--|--|
| V _{DS} (V) | $r_{DS(on)}\left(\Omega\right)$ | I _D (A) ^a | | | |
| 60 | 0.025 at V _{GS} = 10 V | 45 | | | |
| 00 | 0.030 at V _{GS} = 4.5 V | 40 | | | |

FEATURES

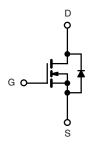
- Trench Power MOSFET
- 175 °C Junction Temperature



1



Drain Connected to Tab



N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS $T_C = 25$ °C, unless otherwise noted | | | | | | | |
|---|-----------------------------------|-----------------|----------------|------|--|--|--|
| Parameter | | Symbol | Limit | Unit | | | |
| Gate-Source Voltage | | V _{GS} | ± 20 | V | | | |
| Continuous Proin Current /T 175 °C\b | T _C = 25 °C | I- | 45 | | | | |
| Continuous Drain Current (T _J = 175 °C) ^b | T _C = 100 °C | l _D | 35 | | | | |
| Pulsed Drain Current | I _{DM} | 100 | Α | | | | |
| Continuous Source Current (Diode Conduction) | I _S | 23 | | | | | |
| Avalanche Current | I _{AS} | 20 | | | | | |
| Single Avalanche Energy (Duty Cycle ≤ 1 %) | L = 0.1 mH | E _{AS} | 20 | mJ | | | |
| Marianum Davier Dissination | T _C = 25 °C | В | 100 | W | | | |
| Maximum Power Dissipation | T _A = 25 °C | P _D | 3 ^a | l vv | | | |
| Operating Junction and Storage Temperature Range | T _J , T _{stg} | - 55 to 175 | °C | | | | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|--|--------------|-------------------|---------|---------|------|--|
| Parameter | | Symbol | Typical | Maximum | Unit | |
| Maximum Junction-to-Ambient ^a | t ≤ 10 sec | R _{thJA} | 18 | 22 | °C/W | |
| Maximum Junction-to-Ambient | Steady State | | 40 | 50 | | |
| Maximum Junction-to-Case | | R _{thJC} | 3.2 | 4 | | |

Notes

a. Surface Mounted on 1" x 1" FR4 board, $t \le 10$ sec.



| SPECIFICATIONS T _J = 25 °C, unless otherwise noted | | | | | | | |
|---|----------------------|---|-------------------------|------------------|-------|------|--|
| Parameter | Symbol | Test Conditions | Min | Typ ^a | Max | Unit | |
| Static | Т | | | 1 | | | |
| Drain-Source Breakdown Voltage | V _{(BR)DSS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | 60 | | | V | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | 1.0 | 2.0 | 3.0 | | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA | |
| | | $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$ | | | 1 | | |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$ | | | 50 | μΑ | |
| | | $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 \text{ °C}$ | | | 250 | 7 | |
| On-State Drain Current ^b | I _{D(on)} | $V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$ | 50 | | | Α | |
| | | V _{GS} = 10 V, I _D = 15 A | 0.025 0.055 0.069 | | | Ω | |
| D : 0 | r | V _{GS} = 10 V, I _D = 15 A, T _J = 125 °C | | | | | |
| Drain-Source On-State Resistance ^b | r _{DS(on)} | V _{GS} = 10 V, I _D = 15 A, T _J = 175 °C | | | | | |
| | | $V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$ | | 0.030 | | | |
| Forward Transconductance ^b | 9 _{fs} | V _{DS} = 15 V, I _D = 15 A | | 20 | | S | |
| Dynamic ^a | | | | | | | |
| Input Capacitance | C _{iss} | | | 1500 | | | |
| Output Capacitance | C _{oss} | $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$ | | 140 | | pF | |
| Reverse Transfer Capacitance | C _{rss} | | | 60 | | | |
| Total Gate Charge ^c | Q_g | | | 11 | 17 | | |
| Gate-Source Charge ^c | Q_{gs} | $V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 23 \text{ A}$ | | 3 | | nC | |
| Gate-Drain Charge ^c | Q_{gd} | | | 3 | | | |
| Turn-On Delay Time ^c | t _{d(on)} | | | 8 | 15 | | |
| Rise Time ^c | t _r | $V_{DD} = 30 \text{ V}, R_{L} = 1.3 \Omega$ | | 15 | 25 | ns | |
| Turn-Off Delay Time ^c | t _{d(off)} | $I_D \cong 23 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$ | | 30 | 45 | | |
| Fall Time ^c | t _f | | | 25 | 40 | | |
| Source-Drain Diode Ratings and Cha | racteristics | (T _C = 25 °C) | | • | | | |
| Pulsed Current | I _{SM} | | | | 50 | Α | |
| Diode Forward Voltage | V_{SD} | I _F = 15 A, V _{GS} = 0 V | | 1.0 | 1.5 | ٧ | |
| | t _{rr} | I _F = 15 A, di/dt = 100 A/μs | | | | | |

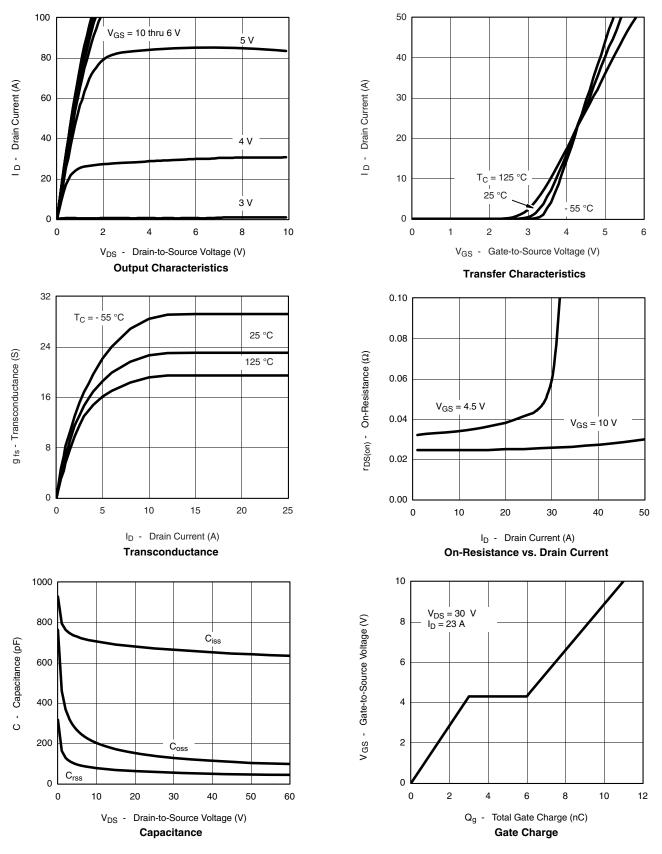
Notes:

- a. For design aid only; not subject to production testing.
- b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

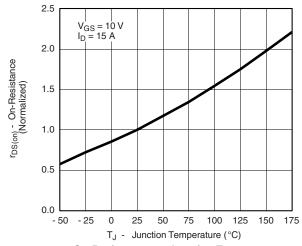


TYPICAL CHARACTERISTICS 25 °C unless noted





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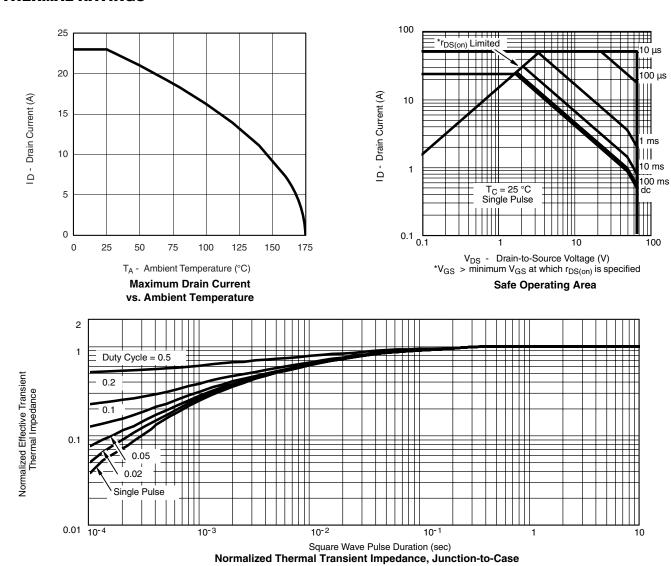
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On-Resistance vs. Junction Temperature

Source-Drain Diode Forward Voltage

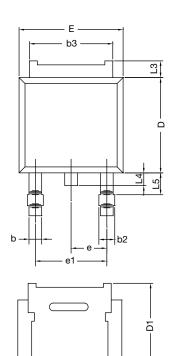


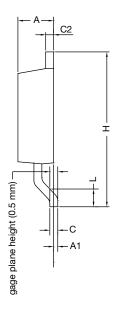
THERMAL RATINGS





TO-252AA CASE OUTLINE





| | MILLIN | METERS | INC | HES | | |
|---------------------------------|--------|--------|-----------|-------|--|--|
| DIM. | MIN. | MAX. | MIN. | MAX. | | |
| А | 2.18 | 2.38 | 0.086 | 0.094 | | |
| A1 | - | 0.127 | - | 0.005 | | |
| b | 0.64 | 0.88 | 0.025 | 0.035 | | |
| b2 | 0.76 | 1.14 | 0.030 | 0.045 | | |
| b3 | 4.95 | 5.46 | 0.195 | 0.215 | | |
| С | 0.46 | 0.61 | 0.018 | 0.024 | | |
| C2 | 0.46 | 0.89 | 0.018 | 0.035 | | |
| D | 5.97 | 6.22 | 0.235 | 0.245 | | |
| D1 | 5.21 | - | 0.205 | - | | |
| Е | 6.35 | 6.73 | 0.250 | 0.265 | | |
| E1 | 4.32 | - | 0.170 | - | | |
| Н | 9.40 | 10.41 | 0.370 | 0.410 | | |
| е | 2.28 | BSC | 0.090 | BSC | | |
| e1 | 4.56 | BSC | 0.180 BSC | | | |
| L | 1.40 | 1.78 | 0.055 | 0.070 | | |
| L3 | 0.89 | 1.27 | 0.035 | 0.050 | | |
| L4 | - | 1.02 | - | 0.040 | | |
| L5 | 1.14 | 1.52 | 0.045 | 0.060 | | |
| ECN: X12-0247-Rev. M, 24-Dec-12 | | | | | | |

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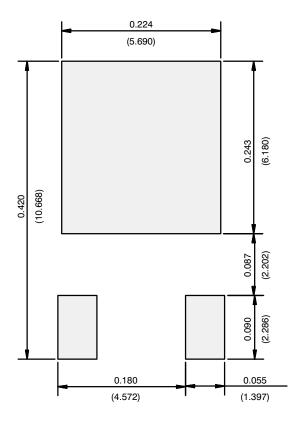
DWG: 5347

Note

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)



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